Product Specification 产品规格书

产品生产商:

产品名称 : 3.2寸240*320点阵彩屏模组

规格型号: <u>XY32028C18-V1</u>

部门确认:

研发	工程	品管	审核

印 章:

日期:

客户回签:

采购	工程	品管	确认

印章:

日期:

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REVISION HISTORY

Rev	Description	Page	Date
1.0	Initial Release	All	2022-11-14

1. GENERAL DESCRIPTION

1.1 DESCRIPTION

XY32028C18-V1 is a transmissive type color active matrix TFT (Thin Film Transistor) liquid crystal display (LCD) that uses amorphous silicon TFT as a switching device. This model is composed of a TFT-LCD module (TFT-LCD panel, driver IC and FPC), a back-light unit and. The resolution of 3.2" contains 240 RGB X320 pixels and can display up to 262k colors.

1.2 GENERAL INFORMATION

Items	Specification	Unit	Note
Drive element	a-Si TFT	-	-
LCM outline size	55.04 (H) x 77.50 (V)	mm	
Active area	48.60 (H) x 64.80 (V)	mm	-
Number of pixels	240(H)X320(V)	pixels	-
Pixel arrangement	RGB stripe	-	-
Pixel Pitch	51.6x 56.8	mm	-
Display color	262K	color	-
Viewing direction	ALL	-	-
Controller / Driver	ST7789T3	-	-
Data interface	SPI 4W	-	
Backlight	5 White LEDs In Parallels		
Weight	TBD	g	_

2. ABSOLUTE MAXIMUM RATING

(Ta=25±2°C, Vss=GND=0V)

Characteristics	Symbol	Min.	Тур	Max.	Uni t	Notes
Cupply Voltage	IOVCC	-0.3	-	4.6	٧	
Supply Voltage	VCI	-0.3	1	4.6	٧	
TFT Gate On voltage	VGH	-0.3	-	30	٧	
TFT Gate Off voltage	VGL	-0.3	-	30	٧	
Backlight Forward Current	I _F	-		100	mA	
Operating Temperature	T _{OPR}	-20		+70	ç	(1), (3)
Storage Temperature	T _{STG}	-30		+80	°C	(2), (3)
Humidity	RH	-		90	%	Max. 60 °C

Notes:

- (1) In case of below 0°C, the response time of liquid crystal (LC) becomes slower and the color of panel becomes darker than normal one. Level of retardation depends on temperature, because of the LC characteristics.
- (2) If product is exposed to high temperatures for extended time, there is a possibility of the polarizer film damage which could degrade the optical characteristics.
- (3) Permanent damage to the device may occur if maximum values are exceeded or reverse voltage is loaded.
 - Functional operation should be restricted to the conditions described under normal operating conditions.

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3. ELECTRICAL CHARACTERISTICS

3.1 LCM DC CHARACTERISTICS

(Ta=25±2°C)

Characteristics	Symbol	Min.	Тур.	Max.	Unit	Note
Power Supply Voltage 1	IOVCC	1.65	1.8	3.3	٧	
Power Supply Voltage 2	VCI	2.4	2.75	3.3	V	
Power Supply Voltage 3	-	-	-	-	V	
Power Supply for MTP	VPP	-	-	-	V	
Current Consumption	I _{DD}	-	TBD	-	mA	Normal mode
Current Consumption	I _{DD-SLEEP}		TBD		uA	Sleep mode
Input voltage "L" Level	V _{IL}	GND	-	0.3IOVCC	٧	IOVCC=1.65~
Input voltage "H" Level	V _{IH}	0.7IOVCC	-	IOVCC	٧	3.3
Output voltage "L" Level	V_{oL}	GND	-	0.2IOVCC	V	I _{OL} =1mA
Output voltage "H" Level	V_{oH}	0.8IOVCC	-	IOVCC	V	I _{OH} =-1mA

3.2 BACK-LIGHT UNIT CHARACTERISTICS

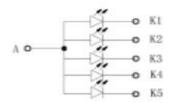
The back-light system is an edge-lighting type with 4 white LEDs. The characteristics of the back-light are shown in the following tables.

(Ta=25±2°C)

Characteristics	Symbol	Condition	Min.	Туре	Max.	Unit	Notes
Forward Voltage	Vf	I∟=100mA	2.8	3.0	3.2	V	-
Forward current	lι		-	100	-	mA	-
Luminance	Lv	I∟=100mA	TBD	TBD	-	cd/m ²	-
LED life time	-	I _L =100mA	20,000	25,000		Hr	Note 1

Note:

(1) The "LED life time" is defined as the module brightness decrease to 50% of original brightness at I_L=80mA. The LED life time could be decreased if operating I_L is larger than 80mA.



VF:3. OV IF:100MA

Bcklight circuit diagram shown in below:

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4. OPTICAL CHARACTERISTICS

The following items are measured under stable conditions. The optical characteristics should be measured in a dark room.

Measuring equipment: BM-5AS, BM-7, EZ-Contrast.

(Ta=25±2°C)

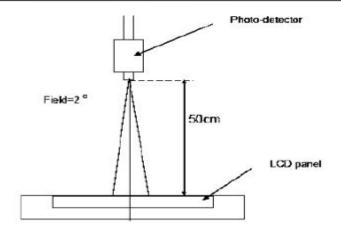
Parame	ter	Symbol	Condition	Min.	Тур.	Max.	Unit	Note
Contrast Ratio (Center point)		C/R	-	280	330	-	-	BM-7 Note(2)
Luminance o		L _w	B/L on	15%	TBD	15%	cd/m ²	CA-210
Luminance ur	niformity	U _W		80	-	-	%	BM-7 Note(3)
Response	Time	Tr + Tf		ı	30	35	ms	BM-5AS Note(4)
	White	W _X	$\theta = 0.$	0.277	0.307	0.337		CA-210 Note(5)
	vviille	Wx	Normal viewing	0.312	0.342	0.372	_	
	Red	R _X	angle	0.592	0.612	0.632		
Color		R _Y	B/L On Note(1)	0.309	0.329	0.349		
Chromaticity (CIE 1931)	Green	G _X		0.279	0.299	0.319		
		Gy		0.547	0.567	0.587		
	Dluc	B _X		0.124	0.144	0.164		
	Blue	B _Y		0.090	0.110	0.130		
	Hon	θ_{T}		-	80	-	Deg	
Viewing	Hor.	θ_{B}	O/D> 40	-	80	-		EZ Contrast
Angle	Vor	θι	C/R≥10	-	80	-		Note(6)
	Ver.	θ_{R}		-	80			
Optima \	/iew Dire	ction		ALL				Note(7)

^{*} This condition will be changed by the evaluation circumstance. If product is exposed to high temperatures for extended time, there is a possibility of the polarizer film damage which could degrade the optical characteristics.

Notes:

(1) Test Equipment Setup: After stabilizing and leaving the panel alone at a given temperature for 30min, the measurement should be executed. Measurement should be executed in a stable, windless, and dark room 30min after lighting the back-light. This should be measured in the center of screen.

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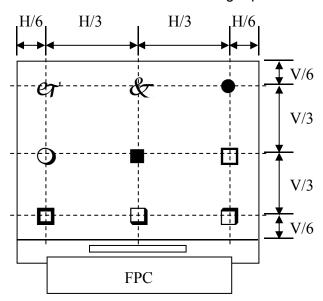


(2) Definition of Contrast Ratio (CR):

(3) Definition of Luminance Uniformity: Active area is divided into 9 measuring areas (Shown in below), every measuring point is placed at the center of each measuring area.

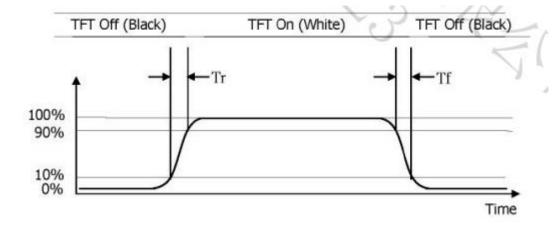
Luminance Uniformity = Min Luminance of white among 9-points

Max Luminance of white among 9-points x100%

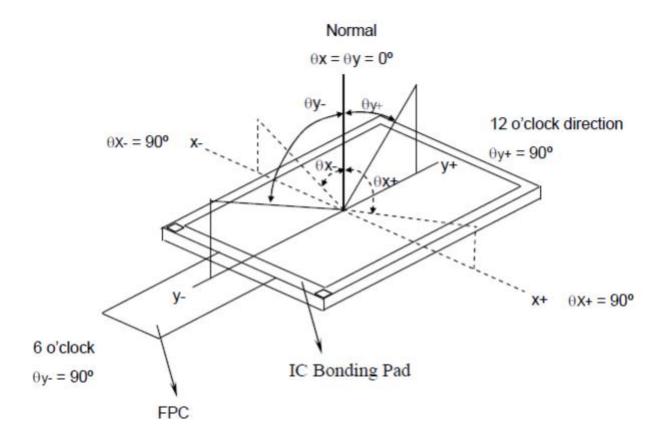


The spot locations for luminance measurement

(4) Definition of Response time: Sum of Tr and Tf.



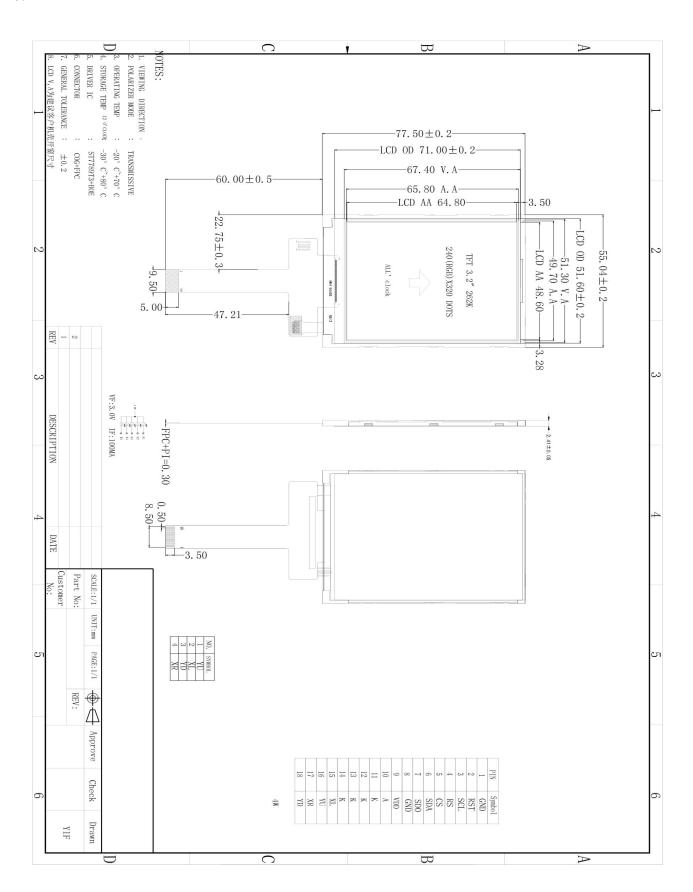
(5) Definition of Viewing Angle: The viewing angle range that the CR≥10.



- (6) Definition of Color Chromaticity (CIE 1931)Color coordinate of white & red, green, blue at center point.
- (7) The different Rubbing Direction will cause the different optima view direction.

5.MODULE OUTLINE DIMENSION

5.



6. MODULE INTERFACE DESCRIPTION

Pin No.	Symbol	Description
1	GND	Power Ground
2	RST	Reset input pin
3	SCL	This pin is used serial interface clock in
4	RS	Serves as command or parameter select.
5	CS	Chip select input pin
6	SDA	The data is applied on the rising edge of the SCL signal
7	SD0	Serial output signal
8	GND	Power Ground
9	VCC	Power supply for interface logic circuits(2.8V)
10	Α	Back-light Anode
11	K	Back-light Cathode
12	K	Back-light Cathode
13	K	Back-light Cathode
14	K	Back-light Cathode
15	XL	TP
16	YU	TP
17	XR	TP
18	YD	TP

7. REFERENCE APPLICATION CIRCUIT

Please consult our technical department for detail information.

8. TIMINGS FOR SPI Interface

7.4.3 Serial Interface Characteristics (4-line serial):

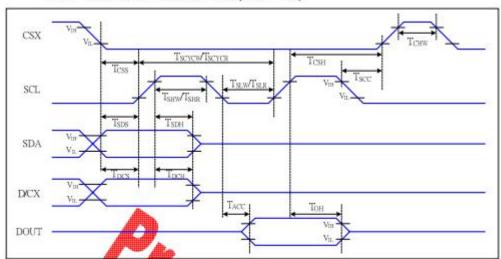


Figure 5 F-line serial Interface Timing Characteristics

VODI=1.65 to 3.3V, VDD=2.4 to 3.3V, AGND=DGND=0V, Ta=-30 to 70 ℃

Signal	Symbol	Parameter	MIN	MAX	Unit	Description
	T _{CSS}	Chip select setup time (write)	15		ns	
	Тсян	Chip select hold time (write)	15		ns	
CSX	T _{CSS}	Chip select setup time (read)	60		ns	
	T _{scc}	Chip select hold time (read)	65	PAP	ns	
	Тсни	Chip select "H" pulse width	40	4	/ns	
	Tscycw	Serial clock cycle (Write)	66	Ad	ns	-write command & data
	T _{SHW}	SCL "H" pulse width (Write)	15	- Allia	ns	ram
SCL	T _{SLW}	SCL "L" pulse width (Write)	15		ns	lalli
SUL	Tacyon	Serial clock cycle (Read)	150		ns	-read command & data
	T _{SHR}	SCL "H" pulse width (Read)	60		ns	No specific
	T _{SLR}	SCL "L" pulse width (Read)	60		ns	ram
DEV	T _{DCS}	D/CX setup time	10		ns	
DICX	Трсн	D/CX hold time	10		ns	
SDA	T _{SDS}	Data setup time	10		ns	
(DIN)	T _{SDH}	Data hold time	10	332 3	ns	
DOUT	TACC	Access time	10	50	ns	For maximum CL=30pF
DOUT	Тон	Output disable time	15	50	ns	For minimum CL=8pF

Table 6 4-line serial Interface Characteristics

9. RELIABILITY TEST CONDITIONS

No.	Test Item	Test Condition	Notes	
1	High Temperature Storage	+80°C / 240H	Inspection after	
2	Low Temperature Storage	-30°C / 240H	2~4h storage at room temperature,	
3	High Temperature Operating	+70°C / 240H	the sample shall be	
4	Low Temperature Operating	-20°C / 240H	free from defects:	
5	Temperature Cycle	Ta=-10°C~+25~+50°C,10 Cycle,per30min	1. Air bubble in the LCD; 2. Seal leak;	
6	High Temperature /Humidity storage	60°C ,90%RH / 120H	3. Non-display; 4. Missing	
7	Vibration Test	Frequency: 10Hz~55Hz~10Hz Amplitude:1.5mm, 2 hours for each direction of X, Y, Z	segments; 5.Glass crack; 6. The surface shall	
8	Packing Drop Test	Drop to the ground from 1m height, 1 corner, 3 edges, 6 surfaces.	be free from damage.	
9	ESD test	Voltage:±8KV R: 330Ω C: 150pF Air discharge, Three or five times.	7. The electrical characteristics requirements shall be satisfied.	

Remarks:

- (1) The test samples should be applied to only one test item.
- (2) Sample size for each test item is 5~10pcs.
- (3) For High Temperature/Humidity storage test, pure water (resistance>10 $M\Omega$) should be used.
- (4) In case of malfunction defect caused by ESD damage, if it would be recovered to normal state after resetting, it would be judge as a good part.
- (5) Failure judgment criterion: basic specification, electrical characteristic, mechanical characteristic, optical characteristic.

10. PACKING SPECIFICATION

TBD

11. INSPECTION CRITERION

Inspection item			Judgement standard			
					Acceptabl	Acceptable number
				Category	A zone	B zone
	Black spot, White s		Α	Ф≦0.10	Ignored	Ignored
	Bright Spot, Pinhole Foreign Particle, Bubble and Particle Between polarizer and $\Phi = (a+b)/2 (mm)$ glass, scratch on polarizer		В	0.10<Φ≦0.20	2	
			С	Φ>0.2	0	
			Total defective point(B,C)		3	
		Bright spot		0.15<Φ≦0.20	N≤2	Ignored
	Pixel point defect	Dark spot/ Black spot		0.15<Φ≦0.20	N≤2	
1		Attached to the two pixels are bright spots		0.15<Φ≦0.20	N≤2	
		Even a two pixel is dark	0.15<Φ≦0.20		N≤2	
		Pixel total number 0.15<Φ≦0.20		N≤2		
		Note1: the spot defect caused by foreign matter is judged according				
		to the defect of the foreign body. Note 2: when the light is not wired to show the type of defects.				
	Black line, White line, Bubble and Particle Between Polarizer and glass, Scratch on polarizer	y w	A	W≦0.03 L≦3.0	Ignored	Ignored
		"	B C	0.03 <w≦0.05 l≦3.0<br="">0.05<w< td=""><td>0</td><td></td></w<></w≦0.05>	0	
2		L		Total defective point(B,C)	2	
		W:Width, L:Length(mm)	_	A <0.4	lana ana d	lava a va al
	Contrast variation	h	A B	Φ≦0.1 0.1<Φ≦0.3	Ignored 2	Ignored
3		b	С	Ф>0.3	0	
		$\begin{vmatrix} -a \\ \Phi = (a+b)/2 \text{ (mm)} \end{vmatrix}$		Total defective point(B,C)	2	
4	Bubble inside cell		any size		none	none
	Polarizer defect (if Polarizer is used)	Scratch and damage on polarizer, particle on polarizer or between polarizer and glass.	Refer to item 1 and item 2.			
5				Ф≦0.3	Ignored	Ignored
		Dubble deat and conv	B C	0.3<Φ≦0.5	2	
		Bubble, dent and convex		0.5<Φ Total defective point(B,C)	2	

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Inspection item			Judgement standard			
		Catamani	Acce	Acceptable number		
		Category	A zone	B zone		
	Surplus glass	①Stage surplus glas	ss b≦0.3mm			
6		glass		outline dimension and assembling.		
7	MURA	①MURA	not allow the appear is not obvious, the solution Note: the principle of installed on the who not find it in the not Inspection basis: 6% (MURA mainly in the relatively dark will)	Naked eye examination: red, green, blue screen does not allow the appearance, black screen requires visual is not obvious, the specific reference limit samples. Note: the principle of closing the sample is to be installed on the whole machine and the end user will not find it in the normal usage scenario. Inspection basis: 6%ND (MURA mainly in the black screen and indoor light is relatively dark will be found, it is recommended to turn off the indoor lighting inspection.)		
		②Point Black / Wh point(MURA)	$D \le 0.10$ mm Ignored 0.10mm $< D \le 0.3$ mm, D>0.3mm: Unquality 2, switch to the red,	; N≦2;		

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Inopostica itaas			Judgment standard		
Inspection item			Category(application: B zone)		
		①The front of lead terminals	Α	If a ≦ t and b ≦ 1.0, c is not limited	
		b		a≦t, 1≦b≦2mm, c≦3mm	
				If glass crack cover alignment mark, b≦0.5mm.	
		w	D	Crack at two sids of lead terminals should not cover patterns and alignment mark	
8 (Glass defect crack	②Surrounding crack—non-contact side Inner border line of the seal Outer border line of the seal Surrounding crack— contact side Seal Inner border line of the seal Outer border line of the seal	b <	Inner borderline of the seal $a \le t$, $b \le 3.0$, $c \le 3.0$ as crack should not cover patterns used for	

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Inspection item			Judgement standard		
9	FPC defect	Component soldering: No cold soldering, short/open circuit, burr, tin ball. The flat encapsulation component position deviation must be less than 1/2 width of the pin (Pic.1); The sheet component deviation: pin deviates from the pad and contact with the near components is not permitted (Pic.2)	Component L≤W/2 W		
		lead defect: The lead lack must be less than 1/2of its width; The lead burr must be less than 1/2 of the seam; Impurities connect with the near leads is not permitted	Soldering pad Lead L2>0 Component L1>0		
		Connector soldering: Soldering tin is at contact position of the plug and socket is not permitted No foundation is scald Serious cave distortion on plug and socket contact pin is not permitted	head Base Board Soldering tin is not permit in this area Soldering tin is not permit in this area socket Base Board		

12. GENERAL PRECAUTIONS

1.1 HANDING

- (1) When the module is assembled, it should be attached to the system firmly. Be careful not to twist and bent the module.
- (2) Refrain from strong mechanical shock and / or any force to the module. In addition to damage, this may cause improper operation or damage to the module and back-light unit.
- (3) Note that display modules are very fragile and could be easily damaged. Do not press or scratch the surface harder than a HB pencil lead.
- (4) Wipe off water droplets or oil immediately. If you leave the droplets for a long time, straining and discoloration may occur.
- (5) If the display module surface becomes contaminated, breathe on the surface and gently wipe it with a soft dry cloth. If it is heavily contaminated, should be wiped by moisten cloth with isopropyl alcohol or ethyl alcohol solvents, DO NOT with water, ketone type materials (e.g. acetone), aromatic, toluene, ethyl acid or methyl chloride, and so on.
- (6) If the liquid crystal material leaks from the panel, it should be kept away from the eyes or mouth. In case of contact with hands, legs or clothes, it must be washed away thoroughly with soap.
- (7) Use finger-stalls with sort gloves in order to keep display clean during the incoming inspection and assembly process.
- (8) Protection film for polarizer on the module shall be slowly peeled off just before use so that the electrostatic charge can be minimized.
- (9) Do not touch directly conductive parts such as the CMOS LSI pad and the interface terminals with bare hands, therefore operations should be grounded whenever he/she comes into contact with the modules.
- (10) Do not exceed the absolute maximum rating value. (The supply voltage variation, input voltage variation, variation in part contents and environmental temperature, and so on), otherwise the module may be damaged.

1.2 SOLDERING

- (1) Use soldering irons with proper grounding and no leakage.
- (2) For No RoHS Product: soldering temperature is 290~350°C, soldering time is 3~5s; for RoHS Product: soldering temperature is 340~370°C, soldering time is 3~5s.
- (3) If soldering flux is used, be sure to remove any remaining flux after soldering (This does not apply in the case of a non-halogen type of flux).

1.3 STORAGE

- (1) DO NOT leave the module in high temperature and high humidity for a long times, keep the temperature from 0°C to 35°C and relative humidity of less than 60%.
- (2) It is highly recommended to store the module in a dark place. The Liquid crystal is deteriorated by ultraviolet, DO NOT leave it in direct sunlight and strong ultraviolet ray for many hours.